

### **MOSFET**

## OptiMOS<sup>™</sup>5 Power-Transistor, 100 V

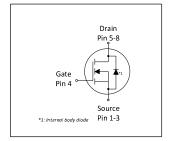
#### **Features**

- Ideal for high frequency switching
- Optimized technology for DC/DC converters
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



| Table 1 Rey 1 citorinance 1 arameters |       |      |  |  |  |  |
|---------------------------------------|-------|------|--|--|--|--|
| Parameter                             | Value | Unit |  |  |  |  |
| $V_{	t DS}$                           | 100   | V    |  |  |  |  |
| R <sub>DS(on),max</sub>               | 9.7   | mΩ   |  |  |  |  |
| I <sub>D</sub>                        | 62    | A    |  |  |  |  |











| Type / Ordering Code | Package        | Marking | Related Links |
|----------------------|----------------|---------|---------------|
| BSZ097N10NS5         | PG-TSDSON-8 FL | 097N10N | -             |



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

| <b>D</b>                                     |                                   | Values      |      |                |      |   |
|--|-----------------------------------|-------------|------|----------------|------|---|
| Parameter                                    | Symbol                            | Min.        | Тур. | Max.           | Unit | Note / Test Condition   |
| Continuous drain current <sup>1)</sup>       | I <sub>D</sub>                    | -<br>-<br>- | -    | 62<br>39<br>11 | А    | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W <sup>2)</sup> |
| Pulsed drain current <sup>3)</sup>           | I <sub>D,pulse</sub>              | -           | -    | 248            | Α    | T <sub>C</sub> =25 °C   |
| Avalanche energy, single pulse <sup>4)</sup> | E <sub>AS</sub>                   | -           | -    | 97             | mJ   | $I_D$ =20 A, $R_{GS}$ =25 $\Omega$  |
| Gate source voltage                          | V <sub>GS</sub>                   | -20         | -    | 20             | V    | -   |
| Power dissipation                            | P <sub>tot</sub>                  | -           | -    | 69<br>2.1      | W    | $T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W <sup>2)</sup>   |
| Operating and storage temperature            | T <sub>j</sub> , T <sub>stg</sub> | -55         | -    | 150            | °C   | IEC climatic category;<br>DIN IEC 68-1: 55/150/56   |

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

| Darameter  | Symbol            |      | Values |      |      | Note / Test Condition |
|--|-------------------|------|--------|------|------|-----------------------|
| Parameter  | Symbol            | Min. | Тур.   | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case                            | R <sub>thJC</sub> | -    | 1.1    | 1.8  | K/W  | -                     |
| Device on PCB,<br>6 cm <sup>2</sup> cooling area <sup>2)</sup> | R <sub>thJA</sub> | -    | -      | 60   | K/W  | -                     |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in

<sup>&</sup>lt;sup>3)</sup> See Diagram 3 for more detailed information<sup>4)</sup> See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

| Damana dam                       | 0                    |      | Values      |             |      | N ( 7 10 10)  |  |
|----------------------------------|----------------------|------|-------------|-------------|------|---|--|
| Parameter                        | Symbol               | Min. | Тур.        | Max.        | Unit | Note / Test Condition   |  |
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub> | 100  | -           | -           | V    | V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA  |  |
| Gate threshold voltage           | $V_{\rm GS(th)}$     | 2.2  | 3.0         | 3.8         | V    | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=36\ \mu{\rm A}$  |  |
| Zero gate voltage drain current  | I <sub>DSS</sub>     | -    | 0.1<br>10   | 1<br>100    | μA   | V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C<br>V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C |  |
| Gate-source leakage current      | I <sub>GSS</sub>     | -    | 10          | 100         | nA   | V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V   |  |
| Drain-source on-state resistance | R <sub>DS(on)</sub>  | -    | 10.3<br>8.3 | 13.0<br>9.7 | mΩ   | V <sub>GS</sub> =6 V, I <sub>D</sub> =5 A<br>V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A  |  |
| Gate resistance <sup>1)</sup>    | R <sub>G</sub>       | -    | 1.2         | 1.8         | Ω    | -   |  |
| Transconductance                 | $g_{fs}$             | 23   | 46          | -           | S    | $ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 20 A$  |  |

 Table 5
 Dynamic characteristics

| Davamatar                                  | Symbol           | Values |      |      | 11::4 | Note / Test Condition  |
|--|------------------|--------|------|------|-------|--|
| Parameter                                  | Symbol           | Min.   | Тур. | Max. | Unit  | Note / Test Condition  |
| Input capacitance <sup>1)</sup>            | C <sub>iss</sub> | -      | 1600 | 2080 | pF    | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz   |
| Output capacitance <sup>1)</sup>           | Coss             | -      | 250  | 325  | pF    | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz   |
| Reverse transfer capacitance <sup>1)</sup> | C <sub>rss</sub> | -      | 12   | 21   | pF    | V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz   |
| Turn-on delay time                         | $t_{\sf d(on)}$  | -      | 11   | -    | ns    | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$             |
| Rise time                                  | t <sub>r</sub>   | -      | 5    | -    | ns    | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$             |
| Turn-off delay time                        | $t_{ m d(off)}$  | -      | 21   | -    | ns    | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$             |
| Fall time                                  | t <sub>f</sub>   | -      | 5    | -    | ns    | $V_{\text{DD}}$ =50 V, $V_{\text{GS}}$ =10 V, $I_{\text{D}}$ =20 A, $R_{\text{G,ext}}$ =3 $\Omega$ |

Gate charge characteristics<sup>2)</sup> Table 6

| Donomoton                          | Cyrrada al                  |      | Values |      |      | Note / Took Condition  |
|------------------------------------|-----------------------------|------|--------|------|------|--|
| Parameter                          | Symbol                      | Min. | Тур.   | Max. | Unit | Note / Test Condition  |
| Gate to source charge              | $Q_{ m gs}$                 | -    | 7      | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold           | $Q_{g(th)}$                 | -    | 4      | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge <sup>1)</sup> | $Q_{ m gd}$                 | -    | 5      | 8    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge                   | $Q_{sw}$                    | -    | 7      | -    | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total <sup>1)</sup>    | Qg                          | -    | 22     | 28   | nC   | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage               | <b>V</b> <sub>plateau</sub> | -    | 4.6    | -    | V    | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V |
| Output charge <sup>1)</sup>        | Q <sub>oss</sub>            | -    | 30     | 40   | nC   | V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V                    |
|                                    | -1000                       |      | 1      | 1    | 1    | 100 11 1, 100 1  |

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Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

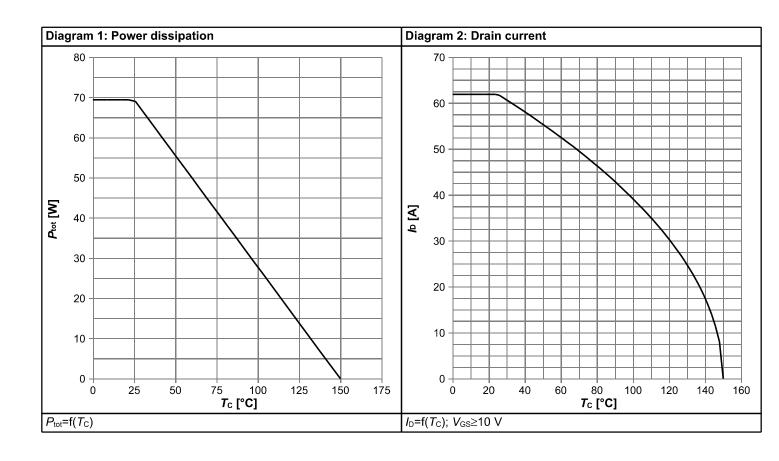


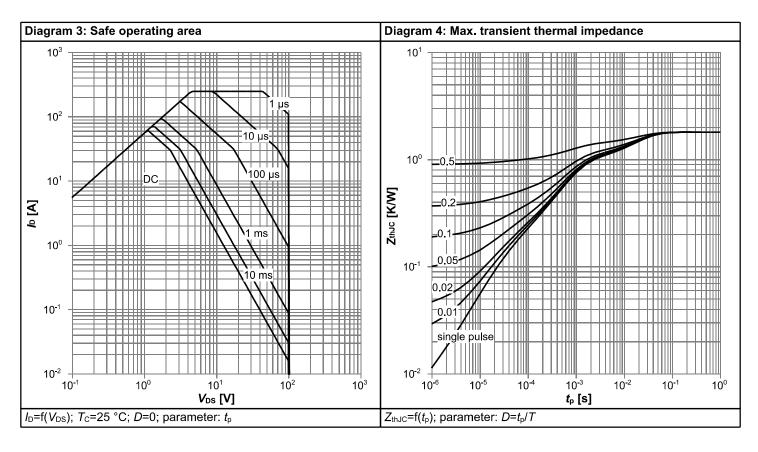
#### Table 7 Reverse diode

| Davamatav                             | Comple of            |      | Values |      |      | Note / Total Constitution   |  |
|---------------------------------------|----------------------|------|--------|------|------|---|--|
| Parameter                             | Symbol               | Min. | Тур.   | Max. | Unit | Note / Test Condition   |  |
| Diode continuous forward current      | Is                   | -    | -      | 48   | Α    | T <sub>C</sub> =25 °C   |  |
| Diode pulse current                   | I <sub>S,pulse</sub> | -    | -      | 248  | Α    | <i>T</i> <sub>C</sub> =25 °C  |  |
| Diode forward voltage                 | V <sub>SD</sub>      | -    | 0.9    | 1.2  | V    | V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C                         |  |
| Reverse recovery time <sup>1)</sup>   | t <sub>rr</sub>      | -    | 43     | 85   | ns   | V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=100 A/μs                  |  |
| Reverse recovery charge <sup>1)</sup> | Qrr                  | -    | 60     | 120  | nC   | V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs |  |

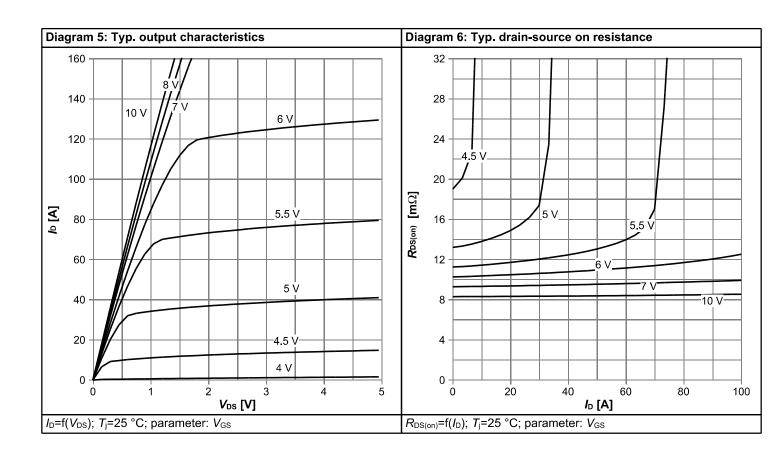


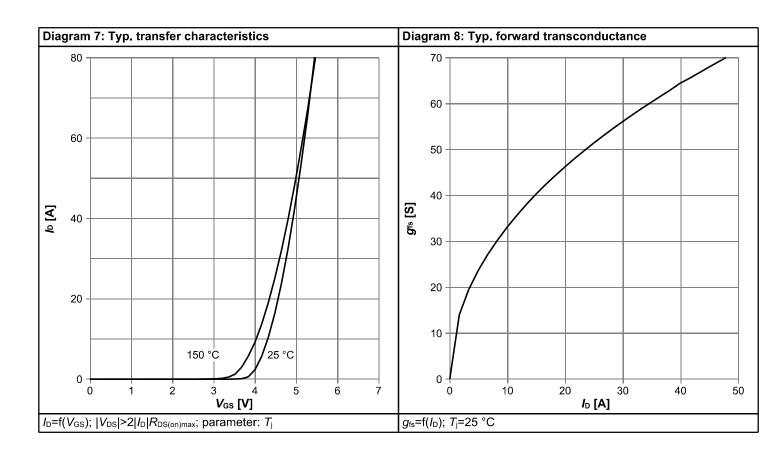
## 4 Electrical characteristics diagrams



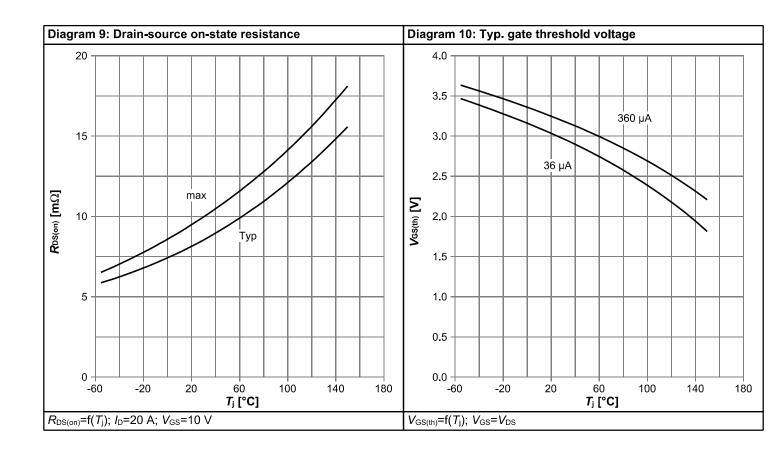


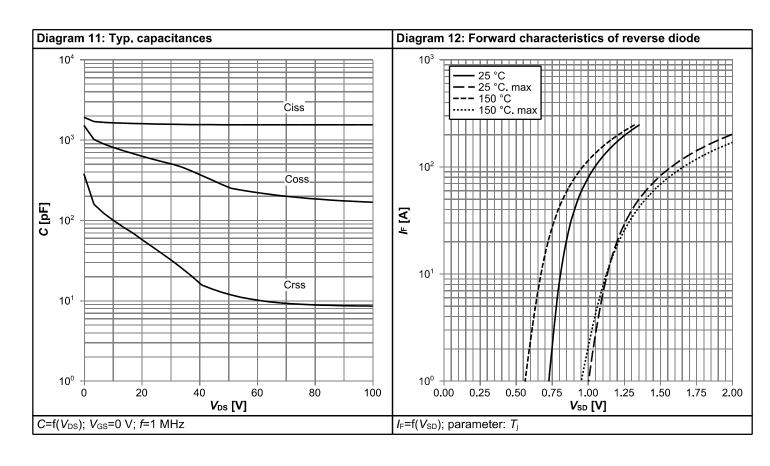




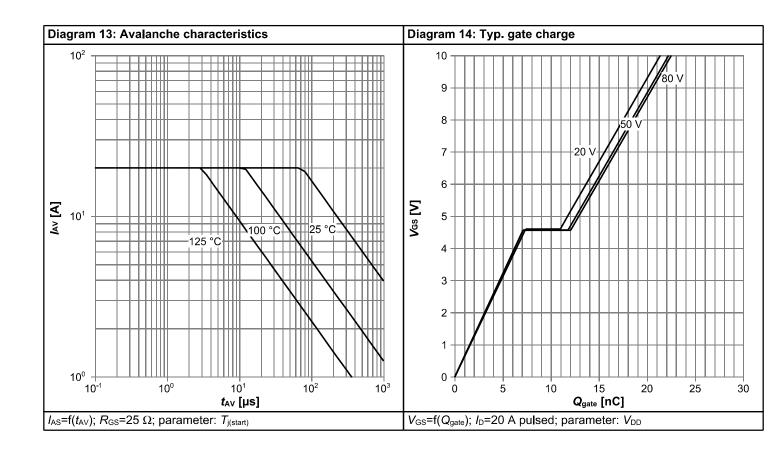


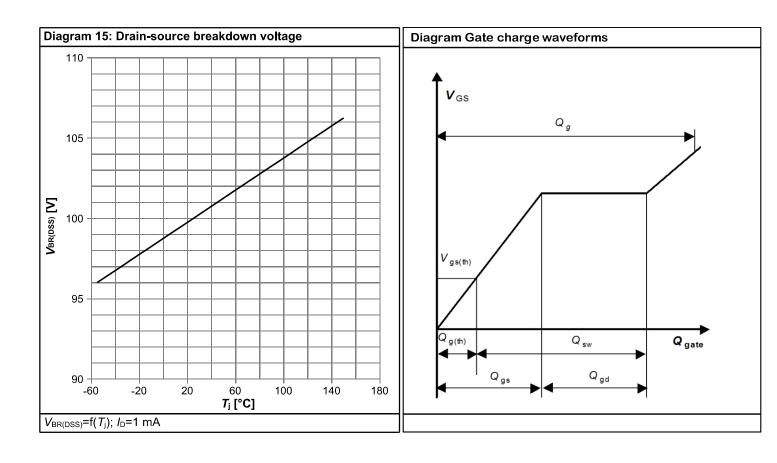






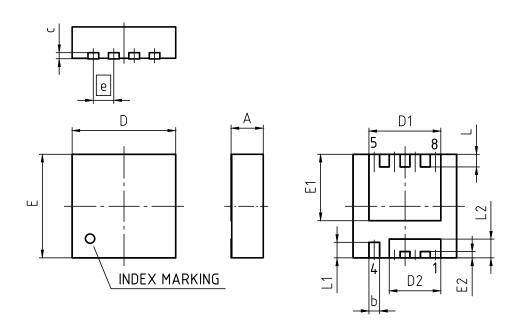








# 5 Package Outlines



| PACKAGE - GROUP<br>NUMBER: | PG-TSDSON-8-U03 |            |  |  |
|----------------------------|-----------------|------------|--|--|
| REVISION: 03               | DATE:           | 20.10.2020 |  |  |
| DIMENSIONS                 | MILLIN          | IETERS     |  |  |
| DIMENSIONS                 | MIN.            | MAX.       |  |  |
| Α                          | 0.90            | 1.10       |  |  |
| b                          | 0.24            | 0.44       |  |  |
| С                          | (0              | .20)       |  |  |
| D                          | 3.20            | 3.40       |  |  |
| D1                         | 2.19            | 2.39       |  |  |
| D2                         | 1.54            | 1.74       |  |  |
| E                          | 3.20            | 3.40       |  |  |
| E1                         | 2.01            | 2.21       |  |  |
| E2                         | 0.10            | 0.30       |  |  |
| е                          | 0.65            |            |  |  |
| L                          | 0.30            | 0.50       |  |  |
| L1                         | 0.40            | 0.60       |  |  |
| L2                         | 0.50            | 0.70       |  |  |
| aaa                        | 0.0             | 06         |  |  |

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



#### **Revision History**

BSZ097N10NS5

Revision: 2021-06-18, Rev. 2.6

#### **Previous Revision**

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.1      | 2014-05-05 | Release of Final Version                     |
| 2.2      | 2016-09-23 | Update Avalanche Energy                      |
| 2.3      | 2017-01-26 | Update Id at Tc=100°C and Ta=25°C            |
| 2.4      | 2020-11-05 | Update Max Id Current Rating                 |
| 2.5      | 2021-02-09 | Update POD                                   |
| 2.6      | 2021-06-18 | Update "Features" and IS                     |

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